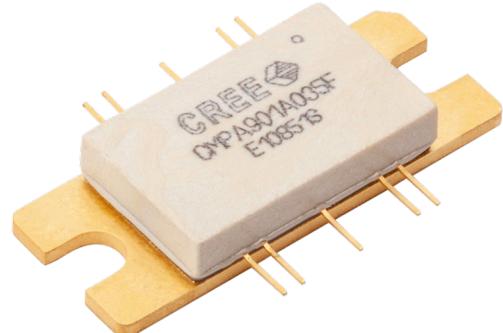


# CMPA901A035F

35 W, 9.0 - 11.0 GHz, GaN MMIC, Power Amplifier

## Description

The CMPA901A035F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC) on a silicon carbide (SiC) substrate. The semiconductor offers 35 Watts of power from 9 to 11 GHz of instantaneous bandwidth. The GaN HEMT MMIC is housed in a thermally-enhanced, 10-lead 25 mm x 9.9 mm metal/ceramic flanged package. It offers high gain and superior efficiency in a small footprint package at 50 ohms.



PN: CMPA901A035F  
Package Type: 440213

## Typical Performance Over 9.0 - 11.0 GHz ( $T_c = 25^\circ\text{C}$ )

CW Performance	9.0 GHz	9.5 GHz	10.0 GHz	10.5 GHz	11.0 GHz	Units
Output Power	46	45	43	42	37	W
Gain	23.7	23.5	23.3	23.2	22.7	dB
Power Added Efficiency	40	36	34	34	35	%

Note: Measured in the CMPA901A035F-AMP application circuit, under CW signal,  $P_{\text{IN}} = 23 \text{ dBm}$

Pulsed Performance	9.0 GHz	9.5 GHz	10.0 GHz	10.5 GHz	11.0 GHz	Units
Output Power	51	52	50	48	40	W
Gain	24.1	24.2	24.0	23.8	23.0	dB
Power Added Efficiency	41.7	38.0	36.5	36.4	35.3	%

Note: Measured in the CMPA901A035F-AMP application circuit, under 100 μs pulse width, 10% duty cycle,  $P_{\text{IN}} = 23 \text{ dBm}$

## Features

- 9.0 - 11.0 GHz Operation
- Typical Output Power 40 W
- Typical Power Gain 23 dB
- Typical PAE 35%
- Operation up to 28 V

## Applications

- Military Radar
- Marine Radar
- Weather Radar
- Medical Applications

**RoHS**  
COMPLIANT



## Absolute Maximum Ratings (not simultaneous) at 25 °C

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V <sub>DS</sub>	84	V <sub>DC</sub>	25 °C
Gate-source Voltage	V <sub>GS</sub>	-10, +2	V <sub>DC</sub>	25 °C
Storage Temperature	T <sub>STG</sub>	-40, +150	°C	
Operating Junction Temperature	T <sub>J</sub>	225	°C	
Maximum Forward Gate Current	I <sub>GMAX</sub>	19	mA	25 °C
Soldering Temperature <sup>1</sup>	T <sub>STG</sub>	245	°C	
Screw Torque	T	40	in-oz	
Thermal Resistance, Junction to Case, CW	R <sub>θJC</sub>	1.3	°C/W	85 °C @ P <sub>DISS</sub> = 80 W
Thermal Resistance, Junction to Case, Pulsed	R <sub>θJC</sub>	0.93	°C/W	85 °C @ P <sub>DISS</sub> = 80 W
Case Operating Temperature	T <sub>C</sub>	-40, +150	°C	

Note:

<sup>1</sup> Refer to the Application Note on soldering at [wolfspeed.com/rf/document-library](http://wolfspeed.com/rf/document-library)

## Electrical Characteristics (Frequency = 9.0 GHz to 11.0 GHz unless otherwise stated; T<sub>c</sub> = 25 °C)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
<b>DC Characteristics<sup>1,2</sup></b>						
Gate Threshold	V <sub>TH</sub>	-3.8	-2.8	-2.3	V	V <sub>DS</sub> = 10 V, I <sub>DS</sub> = 19.8 mA
Saturated Drain Current <sup>3</sup>	I <sub>DS</sub>	14.3	19.8	–	A	V <sub>DS</sub> = 6 V, V <sub>GS</sub> = 2 V
Drain-Source Breakdown Voltage V <sub>BD</sub>	V <sub>BD</sub>	84	–	–	V	V <sub>GS</sub> = -8 V, I <sub>DS</sub> = 19.8 mA
<b>RF Characteristics</b>						
Small Signal Gain	S21	–	34	–	dB	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = -23 dBm
Input Return Loss	S11	–	-6.4	–	dB	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = -23 dBm
Output Return Loss	S22	–	-6.8	–	dB	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = -23 dBm
Output Power <sup>4,5</sup>	P <sub>OUT1</sub>	–	45.7	–	W	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = 23 dBm, Freq = 9 GHz
Output Power <sup>4,5</sup>	P <sub>OUT2</sub>	–	44.7	–	W	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = 23 dBm, Freq = 10 GHz
Power Added Efficiency <sup>4,5,6</sup>	PAE <sub>1</sub>	–	40	–	%	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = 23 dBm, Freq = 9 GHz
Power Added Efficiency <sup>4,5,6</sup>	PAE <sub>2</sub>	–	37	–	%	V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = 23 dBm, Freq = 10 GHz
Output Mismatch Stress	VSWR	–	5:1	VSWR	Ψ	No damage at all phase angles, V <sub>DD</sub> = 28 V, I <sub>DQ</sub> = 1.5 A, P <sub>IN</sub> = 23 dBm, CW

Notes:

<sup>1</sup> At 25 °C

<sup>2</sup> Measured on-wafer prior to packaging

<sup>3</sup> Scaled from PCM data

<sup>4</sup> Measured in the CMPA901A035F-TB fixture (AD-938547)

<sup>5</sup> Fixture loss de-embedded using the following offsets. The offset is subtracted from the input offset value and added to the output offset value

a) 9.0 GHz - 0.20 dB

b) 10.0 GHz - 0.25 dB

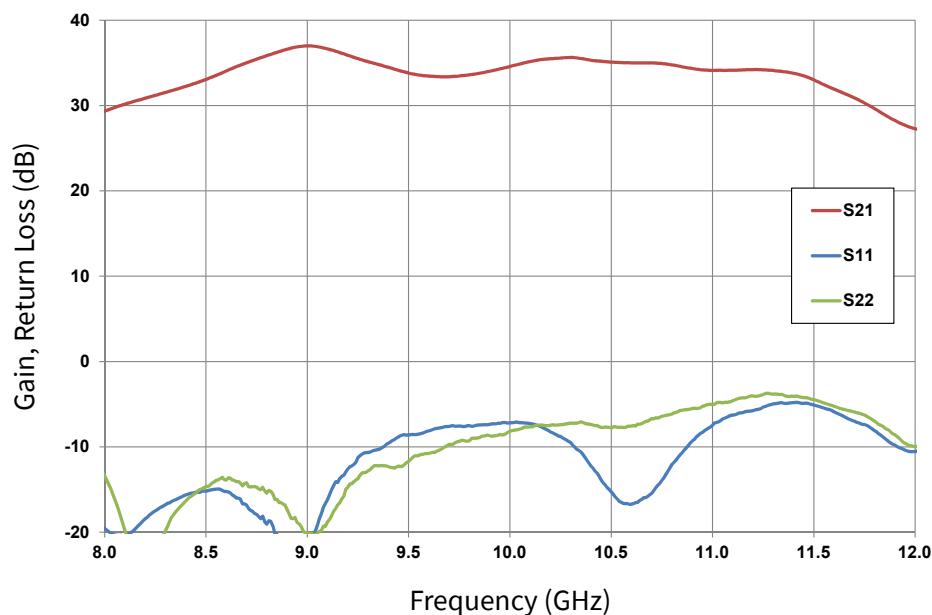
<sup>6</sup> Power added efficiency = (P<sub>OUT</sub> - P<sub>IN</sub>) / P<sub>DC</sub>



## CMPA901A035F Typical Performance

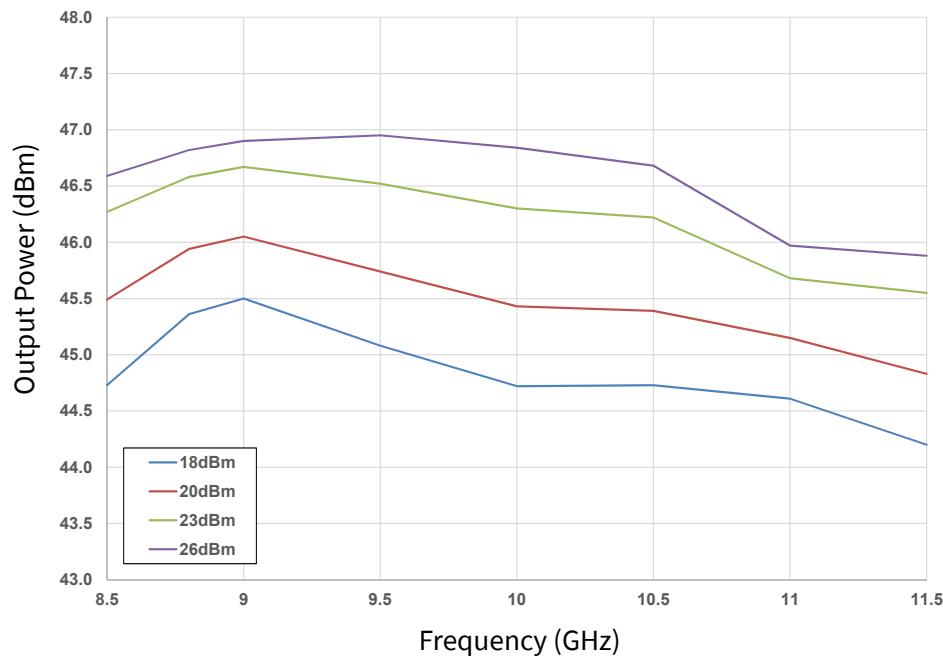
**Figure 1. Small Signal Gain and Return Loss vs. Frequency of the CMPA901A035F as Measured in Circuit CMPA901A035F-AMP Demonstration Amplifier**

$V_{DD} = 28 \text{ V}$ ,  $I_{DQ} = 1.5 \text{ A}$



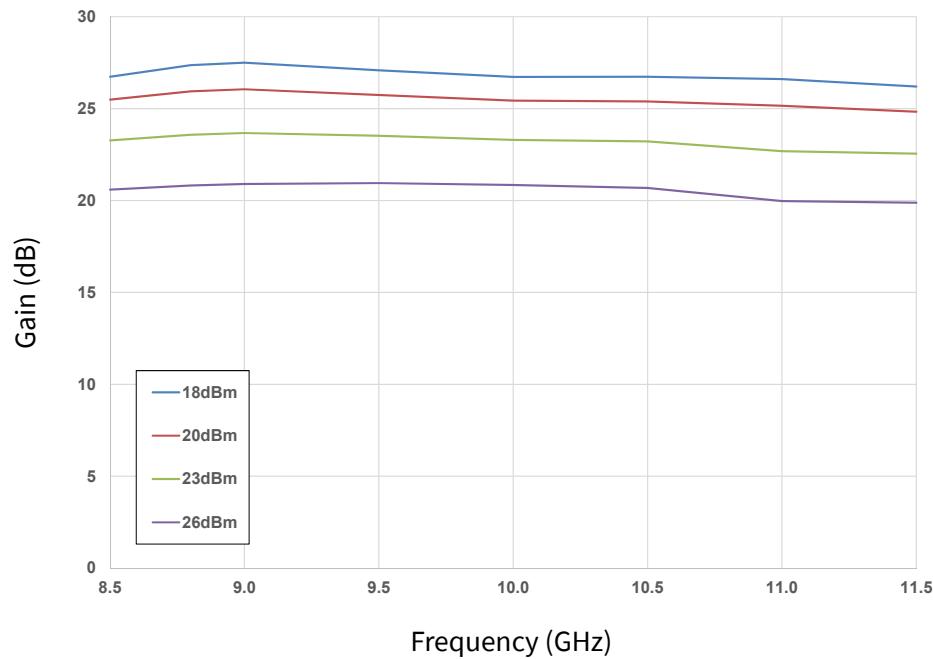
**Figure 2. CW Output Power vs. Frequency as a Function of Input Power of the CMPA901A035F as Measured in Demonstration Amplifier Circuit CMPA901A035F-AMP**

$V_{DD} = 28 \text{ V}$ ,  $I_{DQ} = 1.5 \text{ A}$

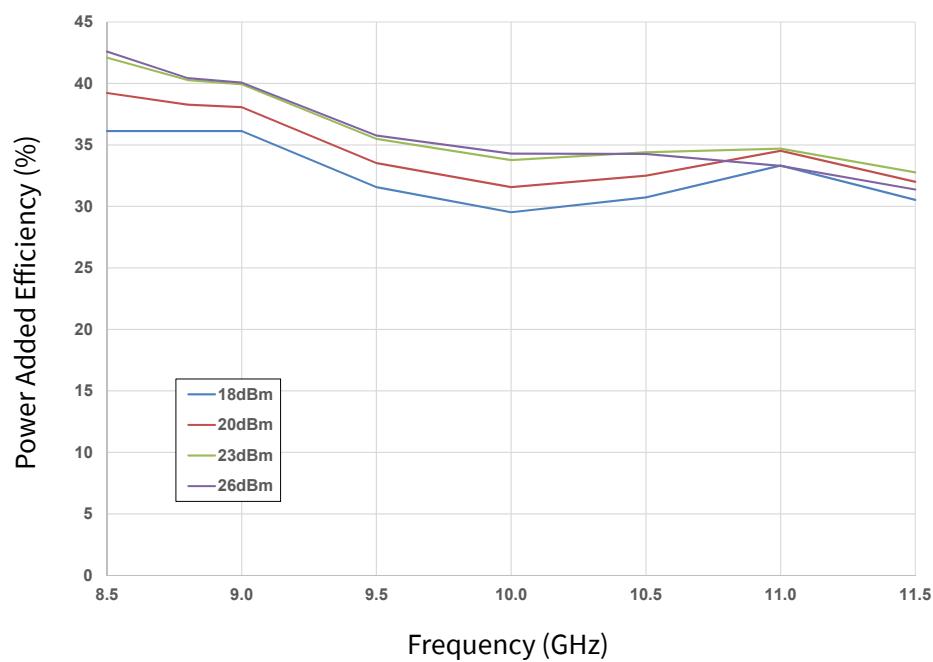


**CMPA901A035F Typical Performance**

**Figure 3. CW Power Gain vs. Frequency as a Function of Input Power**  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 1.5\text{ A}$

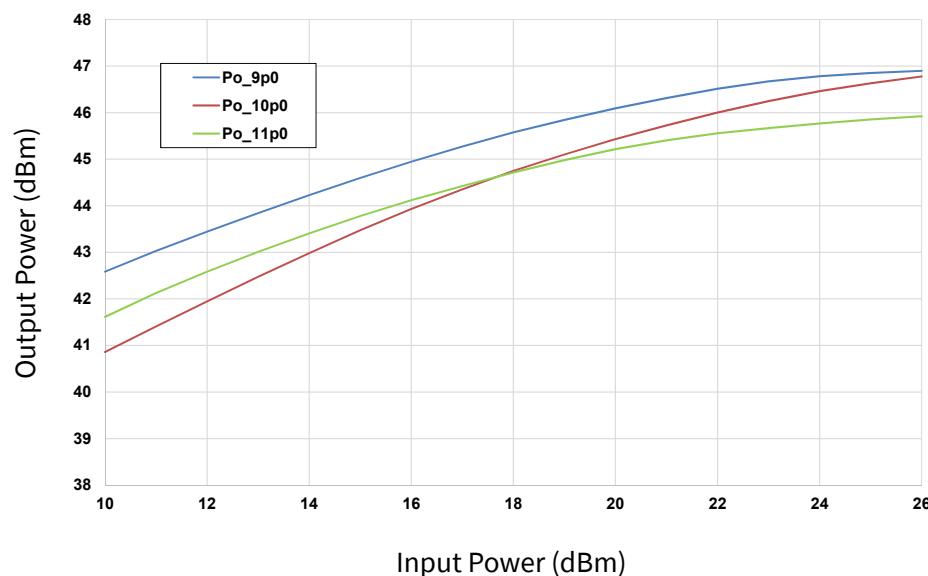


**Figure 4. CW Power Added Efficiency vs. Frequency as a Function of Input Power**  
 $V_{DD} = 28\text{ V}$ ,  $I_{DQ} = 1.5\text{ A}$

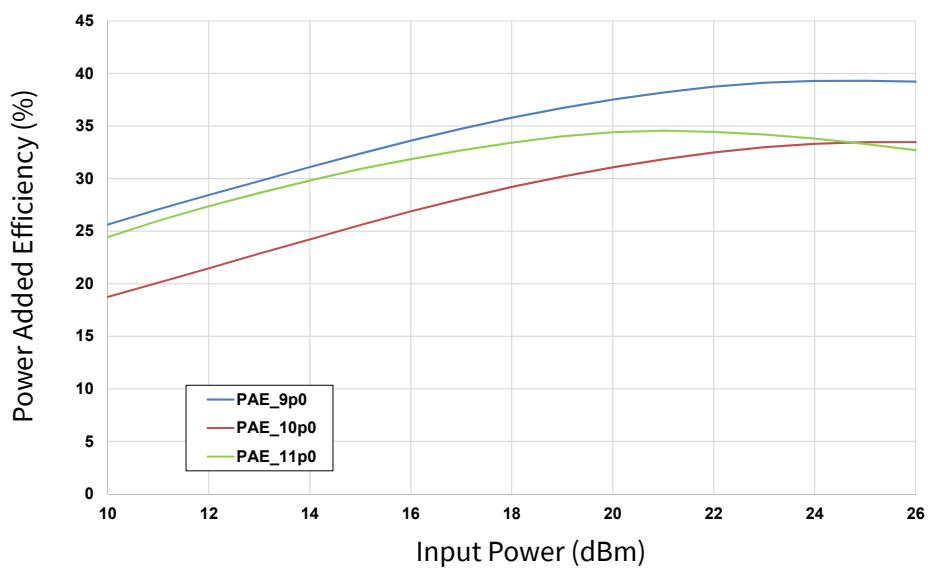


**CMPA901A035F Typical Performance****Figure 5. CW Output Power vs. Input Power as a Function of Input Power**

$$V_{DD} = 28 \text{ V}, I_{DQ} = 1.5 \text{ A}$$

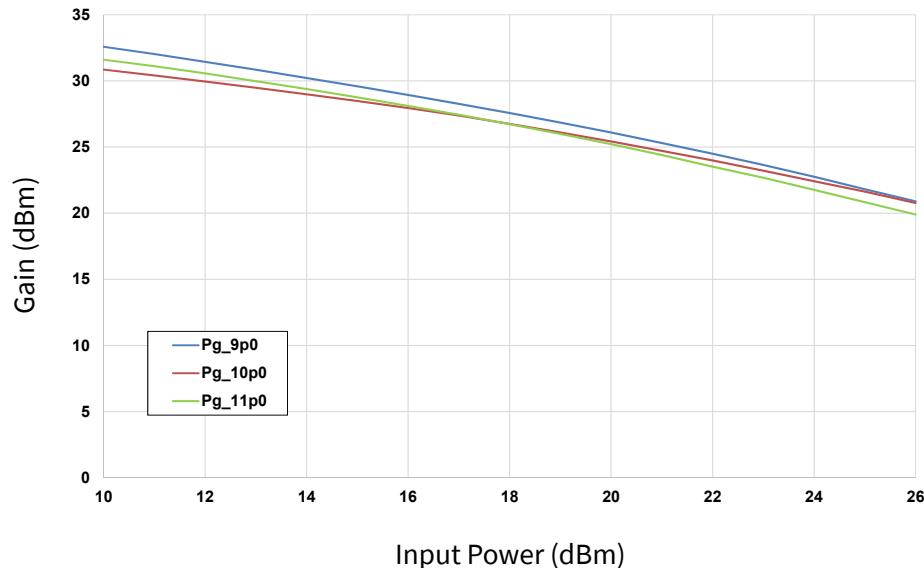
**Figure 6. CW Power Added Efficiency vs. Input Power as a Function of Input Power**

$$V_{DD} = 28 \text{ V}, I_{DQ} = 1.5 \text{ A}$$

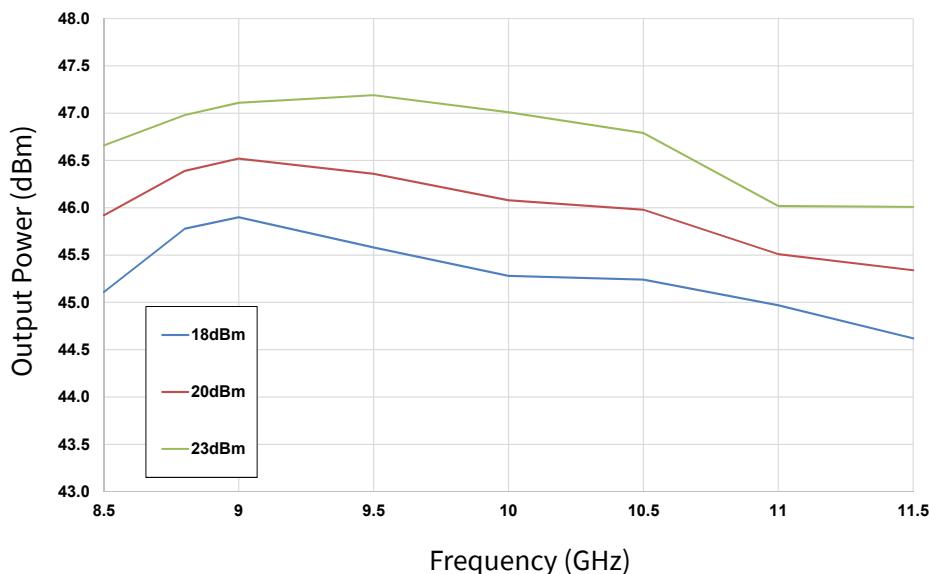


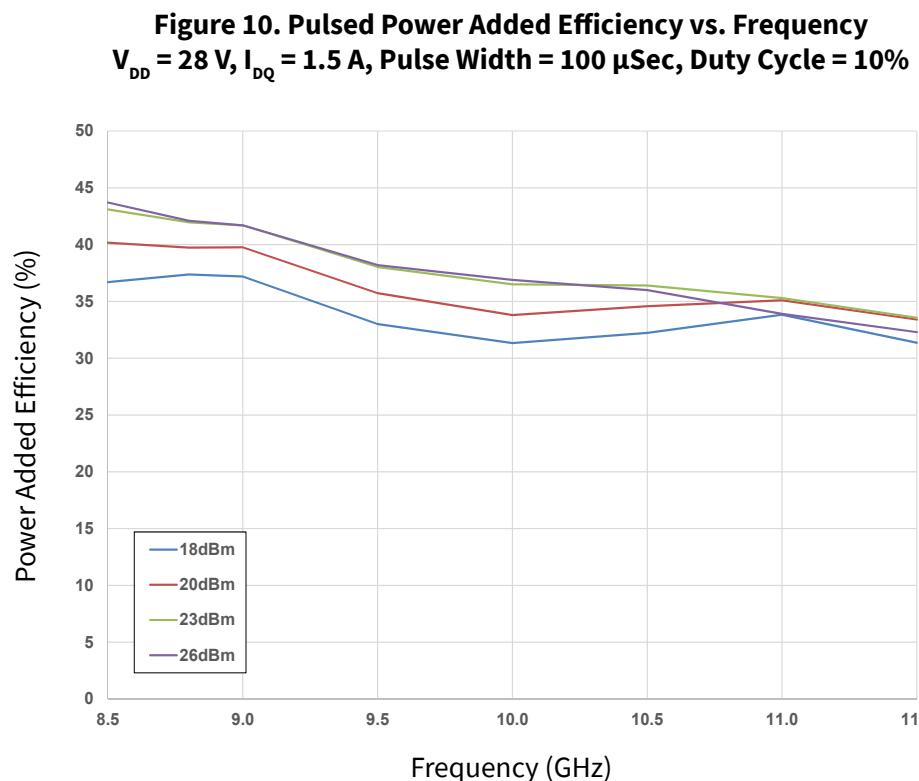
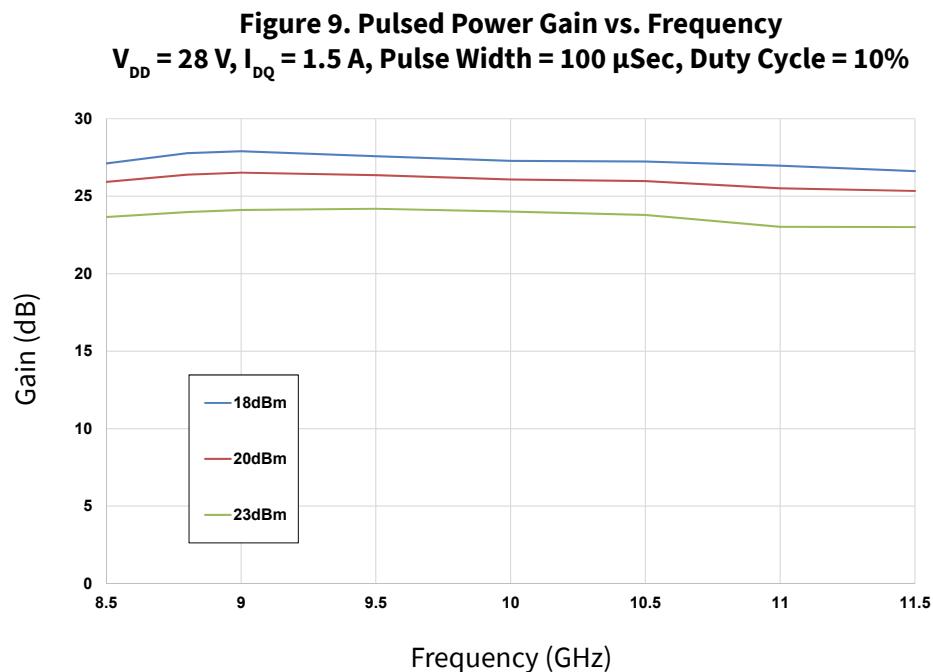
**CMPA901A035F Typical Performance**

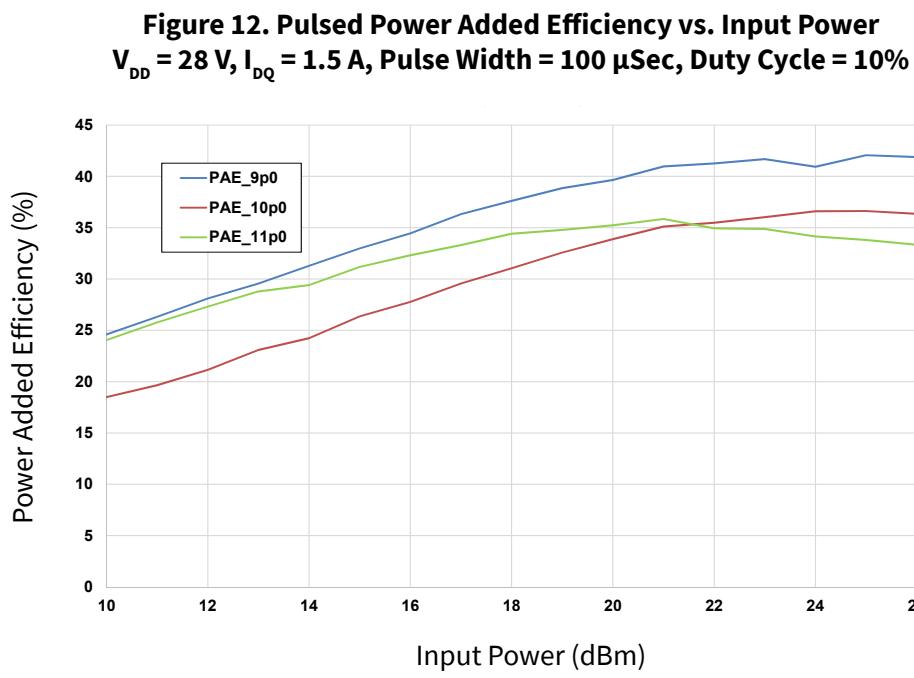
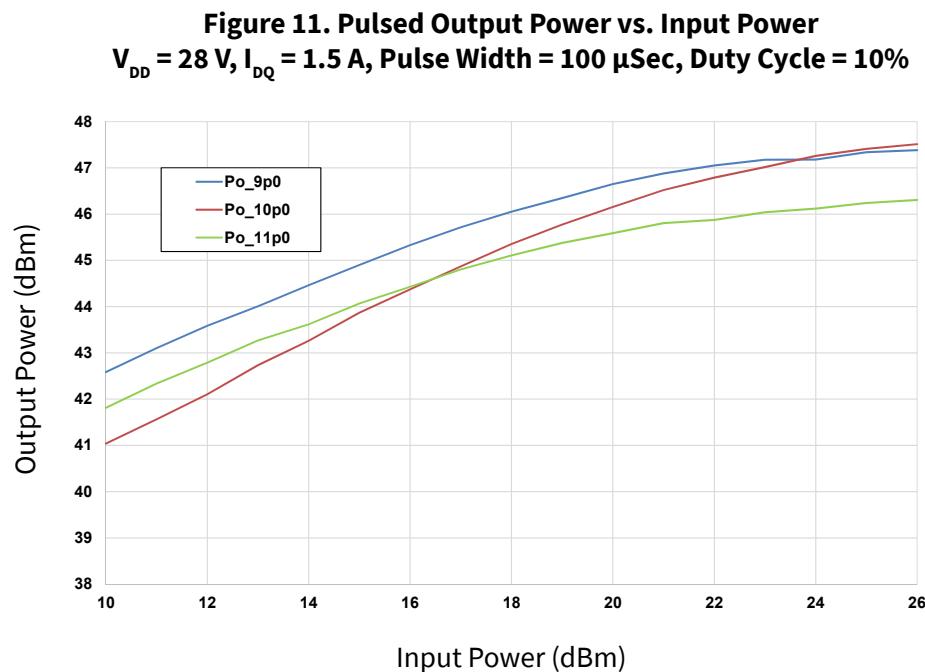
**Figure 7. CW Gain vs. Input Power as a Function of Input Power**  
 $V_{DD} = 28 \text{ V}$ ,  $I_{DQ} = 1.5 \text{ A}$



**Figure 8. Pulsed Output Power vs. Frequency as a Function of Input Power**  
 $V_{DD} = 28 \text{ V}$ ,  $I_{DQ} = 1.5 \text{ A}$ , Pulse Width = 100  $\mu\text{Sec}$ , Duty Cycle = 10%

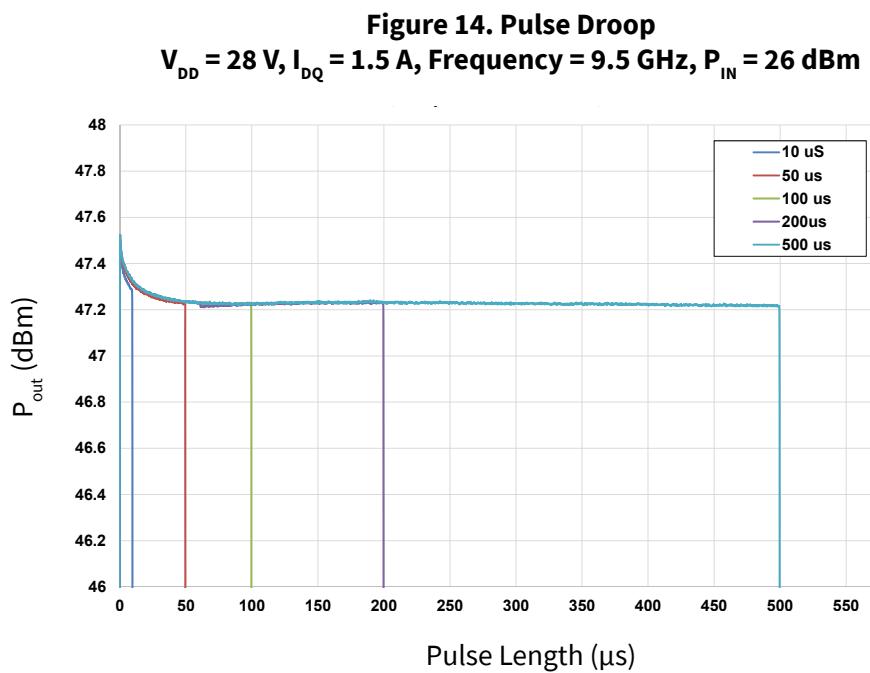
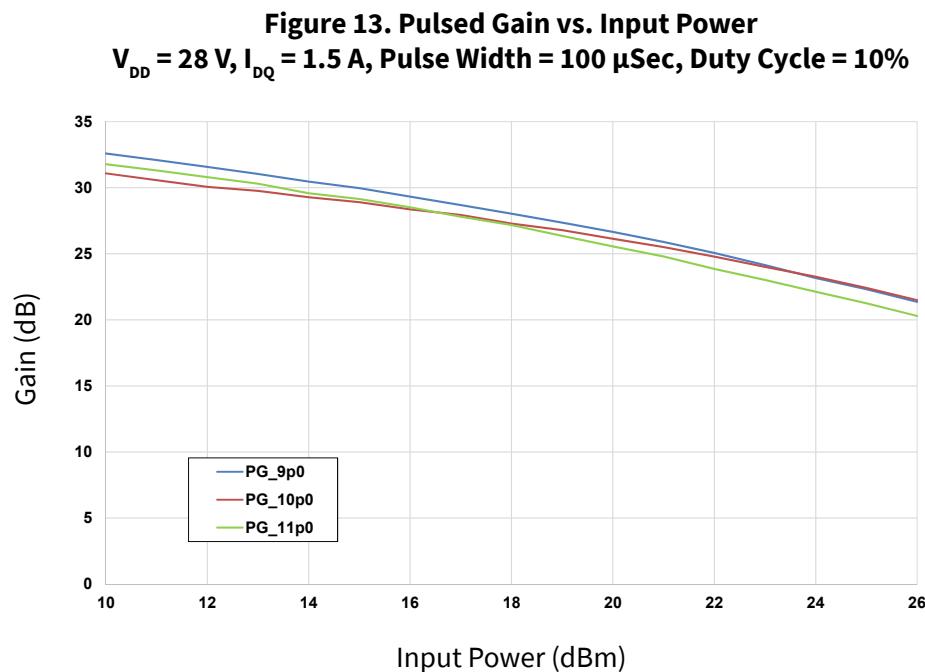


**CMPA901A035F Typical Performance**

**CMPA901A035F Typical Performance**

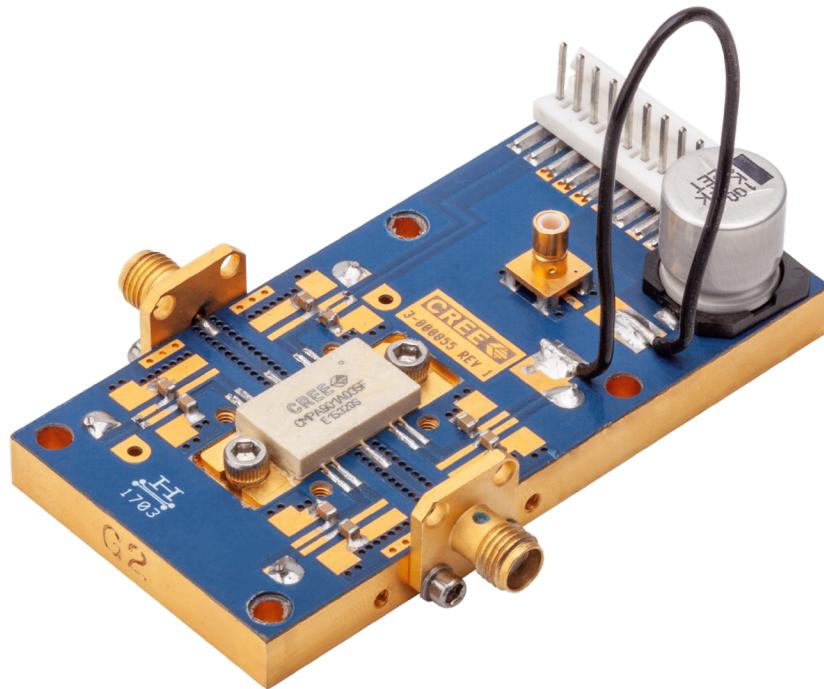


## CMPA901A035F Typical Performance



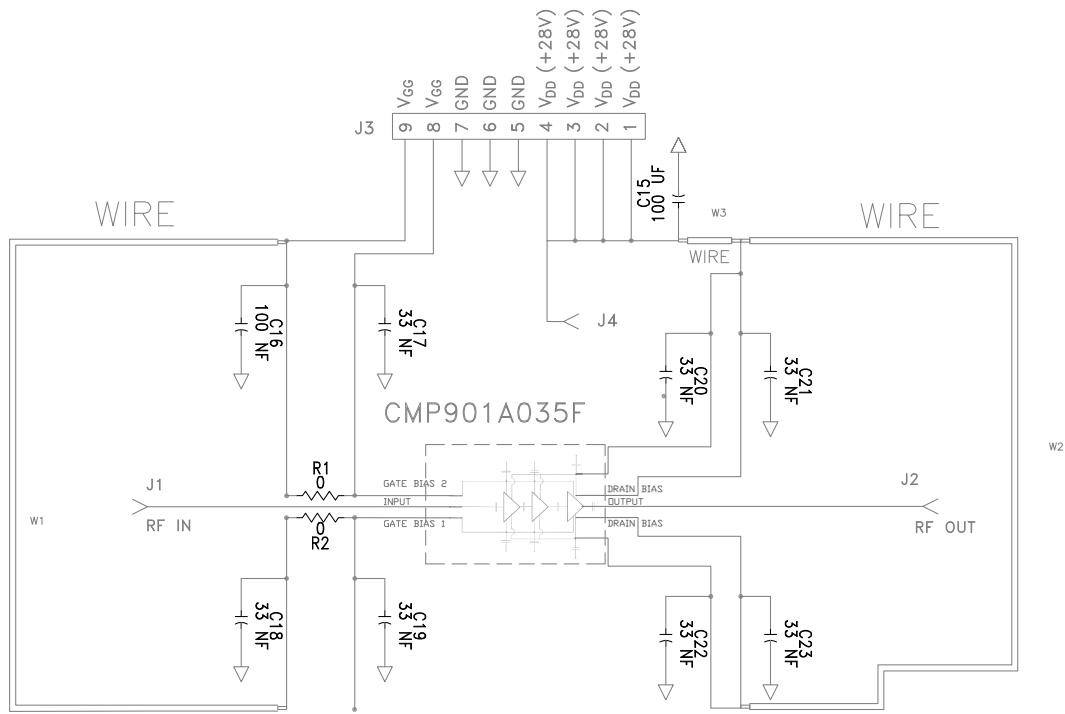
**CMPA901A035F-AMP Demonstration Amplifier Circuit Bill of Materials**

Designator	Description	Qty
C15	CAP ELECT 100UF 80V AFK SMD	1
C16-C23	CAP,33000PF, 0805,100V, X7R	8
R1,R2	RES 0.0 OHM 1/16W 0402 SMD	2
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3	HEADER RT>PLZ .1CEN LK 9POS	1
W1	WIRE, BLACK, 22 AWG ~ 1.50"	1
W2	WIRE, BLACK, 22 AWG ~ 1.75"	1
W3	WIRE, BLACK, 22 AWG ~ 3.0"	1
Q1	CMPA901A035F	1

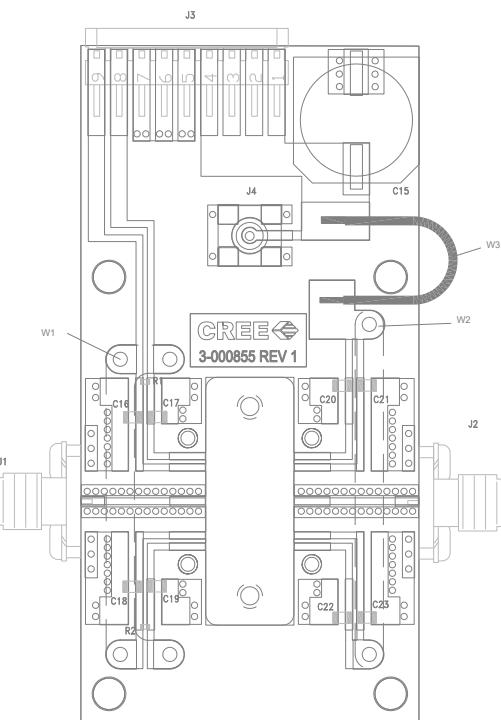
**CMPA901A035F-AMP Demonstration Amplifier Circuit**




## CMPA901A035F-AMP Demonstration Amplifier Circuit Schematic

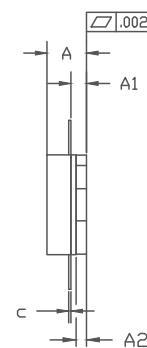
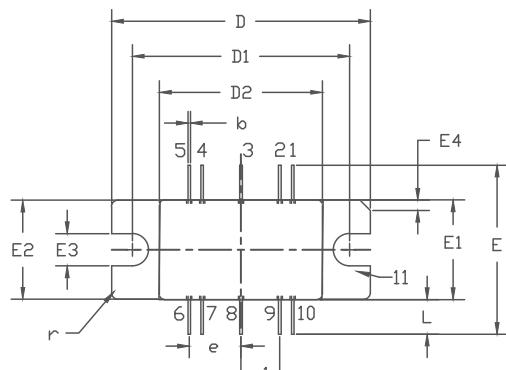


## CMPA901A035F-AMP Demonstration Amplifier Circuit Outline





## Product Dimensions CMPA901A035F



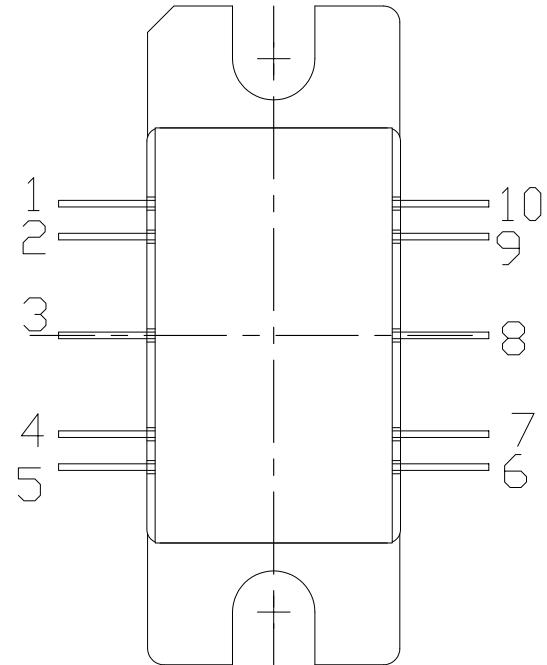
PIN 1: GATE BIAS 6: DRAIN BIAS  
 2: GATE BIAS 7: DRAIN BIAS  
 3: RF IN 8: RF OUT  
 4: GATE BIAS 9: DRAIN BIAS  
 5: GATE BIAS 10: DRAIN BIAS  
 11: SOURCE

### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M - 1994.
2. CONTROLLING DIMENSION: INCH.
3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
4. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.

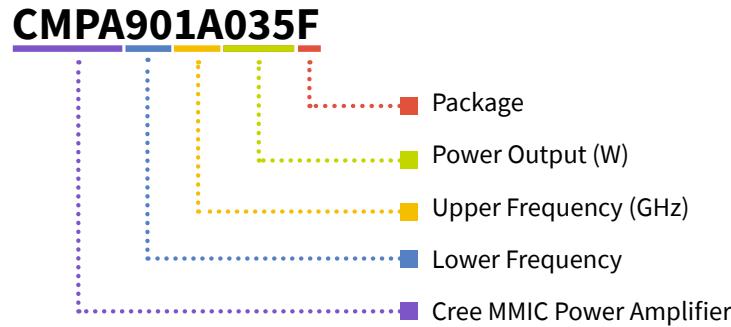
DIM	INCHES		MILLIMETERS		NOTES
	MIN	MAX	MIN	MAX	
A	0.148	0.168	3.76	4.27	
A1	0.055	0.065	1.40	1.65	
A2	0.035	0.045	0.89	1.14	
b	0.01	TYP	0.254	TYP	10x
c	0.007	0.009	0.18	0.23	
D	0.995	1.005	25.27	25.53	
D1	0.835	0.845	21.21	21.46	
D2	0.623	0.637	15.82	16.18	
E	0.653	TYP	16.59	TYP	
E1	0.380	0.390	9.65	9.91	
E2	0.380	0.390	9.65	9.91	
E3	0.120	0.130	3.05	3.30	
E4	0.035	0.045	0.89	1.14	45° CHAMFER
e	0.200	TYP	5.08	TYP	4x
e1	0.150	TYP	3.81	TYP	4x
L	0.115	0.155	2.92	3.94	10x
r	0.025	TYP	.635	TYP	3x

Pin Number	Qty
1	Gate Bias for Stage 1, 2 & 3
2	Gate Bias for Stage 1, 2 & 3
3	RF IN
4	Gate Bias for Stage 1, 2 & 3
5	Gate Bias for Stage 1, 2 & 3
6	Drain Bias
7	Drain Bias
8	RF OUT
9	Drain Bias
10	Drain Bias





## Part Number System



**Table 1.**

Parameter	Value	Units
Lower Frequency	9.0	GHz
Upper Frequency <sup>1</sup>	10.0	GHz
Power Output	35	W
Package	Flanged	-

**Note<sup>1</sup>:** Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

**Table 2.**

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz



## Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA901A035F	GaN HEMT	Each	
CMPA901A035F-AMP	Test board with GaN HEMT installed	Each	

For more information, please contact:

4600 Silicon Drive  
Durham, North Carolina, USA 27703  
[www.wolfspeed.com/RF](http://www.wolfspeed.com/RF)

Sales Contact  
RFSales@wolfspeed.com

RF Product Marketing Contact  
RFMarketing@wolfspeed.com

## Notes

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### Disclaimer

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